Atomic absorption monitor for deposition process control of aluminum at 394 nm using frequency-doubled diode laser

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A monitor for Al vapor density based on atomic absorption (AA) using a frequency-doubled external-cavity-diode-laser source at 394 nm has been demonstrated in both evaporation and sputtering processes. Closed loop operation was achieved for electron-beam evaporated aluminum in a vacuum chamber using the AA signal for feedback. A series of runs in a dc sputtering chamber at the deposition rate of 900 Å/min illustrates the system reproducibility and the possibility of controlling the sputtering process and measuring the spatial distribution of the sputtered atoms with the AA monitor. Coherent light in the blue-UV region (380–430 nm) using quasi-phase-matched lithium niobate waveguides was demonstrated with efficiencies of 25–150%/W, a range of wavelengths that covers many technologically important elements in physical vapor deposition processes. © 1996 American Institute of Physics. [S0003-6951(96)00906-6]

The use of atomic absorption (AA) as a monitor for thickness and composition control in physical vapor deposition processes offers the possibility of improving film and device characteristics in a wide range of industrial applications. Unlike conventional rate monitors, such as quartz crystal monitors (QCM), quadrupole mass spectrometers (QMS), ion gauges, and electron impact emission spectrometers (EIES), monitors based on optical absorption can be simultaneously highly sensitive, noninvasive, and species specific. They are also unaffected by high or low background pressures, and can operate in unusual geometric configurations such as the parallel plate sputtering systems commonly used for high-throughput metallization in the semiconductor industry. Process monitors using AA spectroscopy with incoherent hollow cathode lamps (HCL) have been demonstrated, but suffer from some inherent limitations.1,2

Diode-laser-based monitors offer various advantages. The narrow spectral linewidth and tunability allow a range of advanced spectroscopic techniques to be employed for increasing sensitivity, correcting system drift, and mapping the atomic velocity distribution. The high optical power allows the use of solid state detectors, and in principle allows multiplexing the laser to multiple locations in the deposition system for tomographic imaging.

We have previously demonstrated the monitoring and control of electron beam evaporated yttrium using a diode-laser-based AA monitor operating at 668 nm.3 However, many technologically important elements have relatively strong absorption lines in the blue-UV region, which are not directly accessible with available near-IR diode lasers. Frequency doubling of near-infrared diode lasers is an alternative for obtaining coherent radiation in the blue-ultraviolet region. In this letter, we demonstrate a tunable frequency-doubled-diode-laser-based atomic absorption monitor operating at 394 nm for Al in both evaporation and sputtering processes. Closed loop operation was achieved. Reproducibility of the AA monitor was also investigated.

The AA monitor, consisting of the UV laser source and other components such as an optical isolator, housing for the waveguide, beam delivery optics, and a reference HCL, was integrated onto a 12 in. × 18 in. plate. Figure 1 shows the schematic configuration of the experiment using the UV-laser-based system to probe vacuum deposition chambers used for either evaporation or sputtering.

The UV laser for the AA monitor consisted of a commercially available external cavity diode laser (ECDL) (NewFocus 6100) operating near 788 nm and a quasi-phase-matched lithium niobate waveguide for frequency doubling of the fundamental laser radiation to the UV region. The ECDL was continuously tunable over 20 nm and had a narrow linewidth (<1 MHz), ideal for spectroscopic applications. Typical output powers were 15 mW at operating wavelengths near 800 nm. Quasi-phase-matched second harmonic generation (QPM-SHG) in LiNbO3 waveguides was used for the advantages of both high nonlinear optical conversion efficiency and the capability of operating at any desired wavelength within the transparency range of the crystal.3,5 QPM-SHG waveguides were fabricated using a titanium diffusion technique for ferroelectric domain inversion patterning, followed by an annealed proton exchange (APE) technique for

![FIG. 1. Schematic of the frequency-doubled-diode-laser-based atomic absorption monitor used for deposition processes, shown here with an e-beam evaporation system. HCL, hollow cathode lamp; CIG, chopped ion gauge; QCM, quartz crystal monitor.](http://www.aip.org/aplo/aplcr.jsp)
waveguide formation. The FWHM phase matching bandwidth for QPM-SHG in a LiNbO₃ waveguide is 0.5 Å cm at 788 nm, providing tunable radiation over about 50 GHz in the UV with a 3-dB variation in output power for a 1-cm device. The QPM-SHG waveguide employed for aluminum spectroscopy had a 2.3 μm domain grating period, a 4.0-mm wide, 1-cm long waveguide, and generated radiation at 394 nm with an efficiency of about 70%/W. The output power from the waveguide was about 3 mW with 2.1 mW of fundamental radiation exiting the waveguide. The near-infrared output from the ECDL was passed through a 30-dB optical isolator and coupled into the QPM-SHG waveguide using the conventional endfire technique. The waveguide was mounted inside a compact, temperature controlled housing complete with lenses for coupling the light into and out of the waveguide. Stable coupling efficiencies about 30% were obtained.

The HCL was used as a reference to test and characterize the monitor. The UV radiation passed through the 100% amplitude modulated lamp, and was detected using a photodetector with a transimpedance amplifier in a phase-sensitive detection scheme. By sweeping the laser frequency, the line shape of the absorption was obtained. Aluminum exhibits strong absorption in the $3P_{1/2} - 4S_{1/2}$ transition at 394.4 nm. There exists a hyperfine splitting of 1.5 GHz in the ground state ($3P_{1/2}$). The hyperfine splitting was not resolved in the HCL because the Doppler broadened width of each of the overlapping sublevels was wider than the splitting. The measured width of the overlapped line shape in the HCL was 6.5 GHz. Aluminum also has another transition $3P_{3/2} - 4S_{1/2}$ (396 nm). Calculations of the Boltzmann distribution governed population variations of the two manifolds show that for the vast majority of deposition conditions monitoring one of these transitions is sufficient.

To apply the present system to the evaporation process, the UV radiation was delivered directly into the vacuum deposition chamber as shown in Fig. 1. Derivative spectroscopy was employed, in which the frequency of the fundamental laser was dithered at $f = 170$ Hz with an amplitude of 0.6 GHz, and the $2f$-output from a lock-in amplifier was used for obtaining the absorption signal. The detected signal on line center is proportional to the atomic density. The correlation between the AA signal and the deposition rate was measured by a quartz crystal monitor placed directly above the frequency-doubled laser beam path. The absorption at a deposition rate of 2 Å/s was measured to be 3% for an absorption path length of 10 cm.

Closed loop operation was demonstrated in the electron-beam evaporation chamber at a rate of 2.5 Å/s. The AA signal was used in conjunction with a simple variable-set-point comparator and proportional control for feedback. The deposition rate was also compared with a chopped ion-gauge (CIG) monitor placed above the beam path. The time constant of the lock-in amplifier was 100 ms. Outputs from the AA signal and the CIG are shown in Fig. 2, showing control of the deposition rate using the AA monitor. The signal-to-noise ratio obtained in the experiments indicates that a deposition rate control accuracy of 1% at such a low rate is possible if a reference detector placed before the vacuum chamber is used to normalize the amplitude variations due to frequency dither and etalon effects arising from the waveguide endfaces. The increased noise on the CIG, which is presumably the actual evaporation rate, was observed during open and closed loop operation and was probably due to time-dependent variations in the evaporation plume at the location of the CIG.

The application to sputtering processes and the present system reproducibility of the UV-laser-based monitor were investigated by monitoring the deposition of aluminum in a 2 in. diam dc magnetron sputtering system. The AA monitor configuration was similar to that used in the evaporation chamber. The UV radiation passed between a 2 in. diam aluminum target and a substrate which were separated by 2 in. The absorption path length was about 5 cm. The sputtering condition included a power of 160 W, an argon pressure of 2.2 mTorr, and a background pressure of $4 \times 10^{-6}$ Torr, resulting in a deposition rate of about 900 Å/min and an absorption of 20%.

Two different sets of experiments were performed to ascertain the utility of the optical probe to monitor and control of the sputtering process. First, we compared the film thickness with the overall, line-integrated AA signal; second, we compared the film thickness with the local AA signal using an aperture with a diameter of 1 cm placed between the target and the substrate and above the laser beam. Presputtering was always performed to remove the possible oxidation layer on the aluminum target. Prior to each deposition, the optical monitor was configured to yield the same signal amplitude as observed from the reference HCL. Film thicknesses were measured by masking a portion of the substrate and performing postdeposition profilometry. In each set of experiments the only independent variable was deposition time. Figure 3 shows the relationship between the time-integrated $2f$ AA signal and the thicknesses of the film with and without the aperture. The expected linear behavior for both data sets indicates that the local density of atoms in a sputtering system is correlated with the absorption, and the line integrated absorption can be used as a control variable for thickness. The relative standard deviation of the measured thicknesses was about 6% for both sets of data.

One source of the variation in the data arises due to long term drift in the AA monitor; another source are the difficulties encountered in depositing reproducible metallized aluminum films in the available sputtering system. The long term drift in the current AA monitor stems from frequency excursions in the ECDL and the etalon effects in the QPM-SHG.
waveguide. The former can be corrected by locking the laser frequency to the absorption peak or by sweeping the laser frequency over the entire line shape, and the latter can be eliminated by wedging the waveguide endface. Because no attempt was made in this work to control the reproducibility of the deposition growth morphology, the nonuniformity of the sputtered film hindered reproducible film thickness measurements, although we attempted to configure the target-aperture-substrate-film thickness measurement location identically for each deposition. By improving both the stability of the monitor and the quality of the sputter coating, thickness control with a relative accuracy better than 1% can be expected, suitable for controlling metal deposition, and also for measuring the spatial distribution of the sputtered atoms.

Coherent radiation with different wavelength in the blue-UV region, suitable for AA spectroscopy of many other elements such as tungsten (385 nm), titanium (391 nm), aluminum (394 nm), gallium (403 nm), yttrium (408 nm), etc., is also available by using the present techniques. Figure 4(a) shows phasematching wavelength ($\lambda_p$) versus domain-grating period measured with a widely tunable Ti:sapphire laser. The domain-grating period, controlled by the lithographically delineated Ti film, allows SHG throughout the blue-UV region. Different widths or APE fabrication parameters for waveguides with a given domain-grating period have $\lambda_p$ differing by 1–2 nm, and the temperature tuning rate of the waveguide was measured to be 0.32 Å/°C as shown in Fig. 4(b), indicating that an acceptable operating temperature variation of ±20 °C allows tuning to any desired atomic transition in the 380–430 nm range. The conversion efficiency of these devices ranged from 25 to 150%/W due to variations in the waveguide lithography and domain inversion grading, high enough for diode-laser-based AA spectroscopy applications.

It should be pointed out that because of the strong absorption for elements like aluminum, measurement accuracy is often limited by scale factor effects such as stray etalons, residual power, and frequency variations of the laser rather than the absorption resolution of the system. When the deposition rate is high enough (∼1 μm/min) to produce an opaque vapor, simply detuning the laser frequency from the line center may not provide sufficient sensitivity; suitable schemes for operating in this regime are current research topics.

In summary, we have developed a frequency-doubled-diode-laser-based AA spectroscopy system for monitoring and controlling for thin-film deposition. System demonstrations were carried out for aluminum at 394 nm in both electron-beam evaporation and sputtering processes. Closed loop operation was achieved in an evaporation chamber. We have also demonstrated the possibilities of employing the laser-based system for controlling the thickness of the sputter coated films. Measuring the spatial distribution of sputtered atoms should also be possible. By using quasi-phase-matched lithium niobate waveguides, blue-UV coherent light at 380–430 nm becomes available, and useful for many technologically important elements in physical vapor deposition processes.

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